

### General Description

The 8972 is N-ch MOSFETs with extreme high cell density, which provide excellent R<sub>DS(on)</sub> and gate charge for most of the synchronous buck converter applications.

### Features

- Simple Drive Requirement
- Reliable and Rugged
- Low On-Resistance

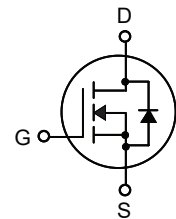
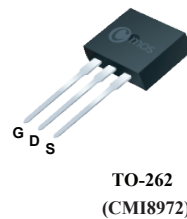
### Product Summary

BVDSS	R <sub>DS(on)</sub>	I <sub>D</sub>
20V	4mΩ	80A

### Applications

- DC/DC converter
- Motor drives
- Power Management in Note book

### TO-262 Pin Configuration



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	20	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current	80	A
I <sub>DM</sub>	Pulsed Drain Current <sup>1</sup>	320	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	45	mJ
P <sub>D</sub>	Total Power Dissipation	100	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	150	°C

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-ambient	---	2.5	°C/W

**Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=30A$	2.8	3.5	4	$m\Omega$
		$V_{GS}=4.5V, I_D=15A$	---	---	6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	0.75	0.9	1.5	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=16V, V_{GS}=0V$	---	---	1	$\mu A$
		$V_{DS}=16V, V_{GS}=0V, T_C=85^{\circ}\text{C}$	---	---	30	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=10V, I_D=20A$	---	35	---	S
$R_g$	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	3	---	$\Omega$
$Q_g$	Total Gate Charge	$I_D=50A$	---	32	---	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=10V$	---	15	---	
$Q_{gd}$	Gate-Drain Charge	$V_{GS}=4.5V$	---	7	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=10V$	---	20	---	ns
$T_r$	Rise Time	$I_D=50A$	---	15	---	
$T_{d(off)}$	Turn-Off Delay Time	$R_G=1\Omega$	---	45	---	
$T_f$	Fall Time	$V_{GEN}=10V$	---	12	---	
$C_{iss}$	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$	---	2500	---	pF
$C_{oss}$	Output Capacitance		---	800	---	
$C_{rss}$	Reverse Transfer Capacitance		---	120	---	

**Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	80	A
$I_{SM}$	Pulsed Source Current <sup>1</sup>		---	---	320	A
$V_{SD}$	Diode Forward Voltage <sup>1</sup>	$V_{GS}=0V, I_{SD}=20A, T_J=25^{\circ}\text{C}$	---	---	1.1	V

Note :

- 1.The data tested by pulsed , pulse width $\leq 300\mu s$  , duty cycle $\leq 2\%$
- 2.The test condition is  $V_{DD}=10V, V_{GS}=10V, L=0.1mH, I_{AS}=30A$

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Typical Characteristics

